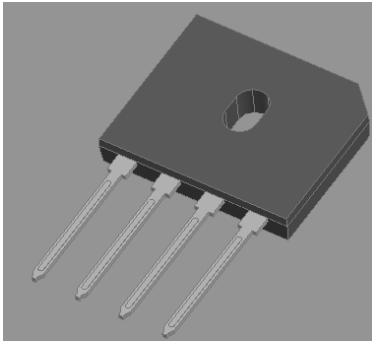


@ck'J : '6f]X [Y'FYWh]Z]Yfg'

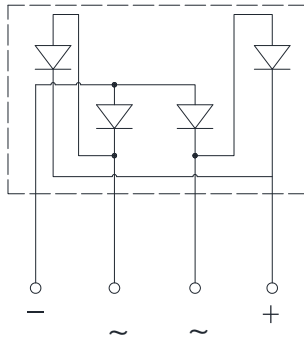


:YUhifYg'

UL recognition, file #E230084  
based on silicon planar process  
Ideal for printed circuit boards  
High surge current capability  
Low VF  
Solder dip 275 °C max. 7 s, per JESD 22-B106

Hmd]WU' '5dd' ]WUh]cbg'

General purpose use in AC/DC bridge full wave Rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.



'AYW\Ub]WU' '8UhU'

DUW\_U[Y: GBU  
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant  
HYf a ]bU'g': Tin plated leads, solderable per J-STD-002 and JESD22-B102  
Dc'Uf]hm. As marked on body

AUI]a i a 'FUh]b [g (T<sub>a</sub>=25 Unless otherwise specified

D5F5A9H9F'		GMA6C@'	IB-H'	; 611%)*
Device marking code				GBUU1506
Maximum Repetitive Peak Reverse Voltage		VRRM	V	600
Maximum RMS Voltage		VRMS	V	420
Maximum DC blocking Voltage		VDC	V	600
Average rectified output current @60Hz sine wave, R-load	With heatsink T <sub>c</sub> =110	IO	A	15.0
	Without heatsink T <sub>a</sub> =25			3.5
Forward Surge Current (Non-repeti(Non- V				
Current squared time @1ms t 8.3ms T <sub>j</sub> =25 , Rating of per diode		I <sup>2</sup> t	A <sup>2</sup> S	200.9
Storage temperature		T <sub>stg</sub>		-55 ~ +150
Junction temperature		T <sub>j</sub>		-55 ~ +150
Dielectric strength @ terminals to case, AC 1 minute		V <sub>dis</sub>	KV	2.5
Mounting torque @recommend torque 5kg cm		T <sub>or</sub>	kg cm	8.0



· ; 6 I I %) \$ \* ·

9`YWhf]WU`7\UfUWhYf]gh]Wg` Ta=25 Unless otherwise specified

D5F5A9H9F`	GMA6C@`	IB-H`	H9GH`7CB8-H-CBG`	A]b`	Hmd`	AUI`
Instantane voltage drop per diode	VF	V	IFM=7.5A	0.80	0.88	0.92
DC reverse current at rated DC blocking voltage per diode	IR	μA	Tj=25	-	0.08	5
			Tj=125	-	2.5	50
Junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	64	128	250

H\Yf a U`7\UfUWhYf]gh]Wg` Ta=25 Unless otherwise specified

D5F5A9H9F`		GMA6C@`	IB-H`	; 6 I I %) \$ *`
Thermal Resistance	Between junction and ambient, Without heatsink	R J-A	/W	25.0
	Between junction and case, With heatsink	R J-C		1.4
	Between junction and Lead With heatsink	R J-L		5



C i h ] b Y ' 8 ] a Y b g ] c b g '

; 6 1 '		
Dim	Min	Max
A	21.80	22.30
B	18.30	18.80
C	17.50	18.00
D	3.30	3.90
E	7.10	7.50
F	5.50	5.90
G	1.91	2.54
H	2.06	2.54



· ; 6 I I %) \$ \* ·

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**8]gW'U]a Yf'**

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